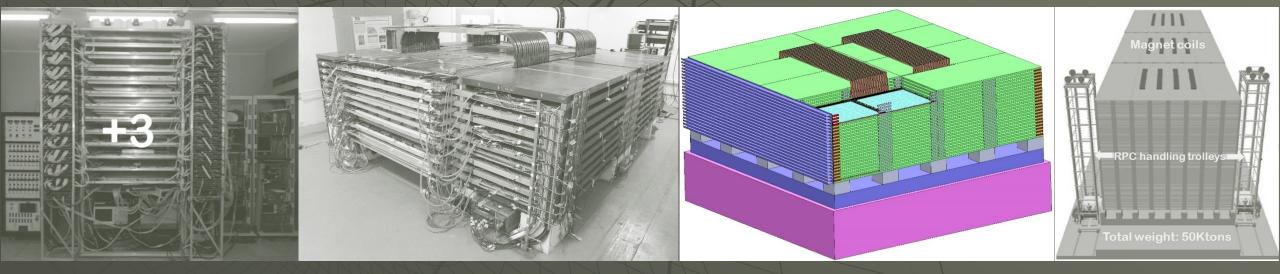
Features, and preparations for the INO's ICAL engineering module



DHEP Annual Meeting 2022, Tata Institute of Fundamental Research Mumbai, May 4-6, 2022

ICAL, e-ICAL and m-ICAL

Parameter	ICAL (51kt)	e-ICAL (700t)	m-ICAL (85t)		
No. of modules	3	1	1		
Module dimensions	16.2m×16m×14.5m	8m×8mx2m (90:1)	4m×4mx1m (720:1)		
Detector dimensions	49m×16m×14.5m	8m×8mx2m	4m×4mx1m		
No. of layers	150	20	10		
Iron plate thickness	56mm	56mm	56mm		
Gap for RPC trays	40mm	40mm	45mm		
Magnetic field	1.3Tesla	1.3Tesla	1.3Tesla		
RPC dimensions	1,950mm×1,910mm×24mm	1,950mm×1,910mm×24mm	1,950mm×1,910mm×24mm		
Readout strip pitch	30mm	30mm	30mm		
No. of RPCs/Road/Layer	8	4	2		
No. of Roads/Layer/Module	8	4	1		
No. of RPC units/Layer	192	16	2		
No. of RPC units	28,800 (107,266m²)	320 (1,192m ²) (90:1)	20 (74.5m ²) (1440:1)		
No. of readout strips	3,686,400	40,960 (90:1)	2,560 (1440:1) 2		

Inter-Institutional Centre for High Energy Physics (IICHEP)



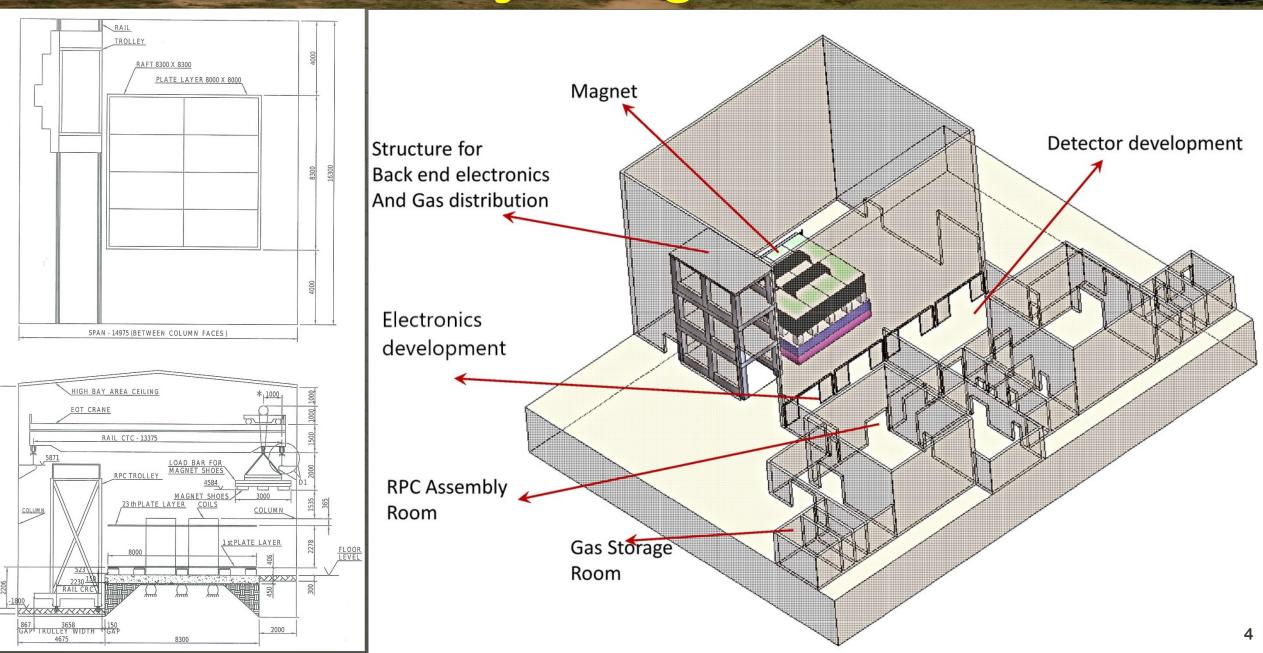
12.2 hectare land close to Madurai Kamaraj University. Centre to operate INO lab, GTP, HRD and detector R&D lab. Geo tech investigation done, boundary wall constructed long ago.

INFEL FIAIH

Centre Site



Laboratory design for e-ICAL



Low carbon steel plates and machining

ESSAR Steel (I) Pvt. Ltd., Hazira Steel Authority of India Ltd., Bhilai Jindal Steel & Power Ltd., Odisha SS Engineering, Mumbai

RPC surface planarity measurement system will be used for qualification.



and a state of the state of the

Green & Green Engineering Solutions, Coimbatore

Inter-plate gap measurement robot

Magnet coil components and assembly



Luvata Pori Oy, Finland



Magnet power supply and measurements



30V, 1500A power supply loaned from VECC for m-ICAL.
Needed chilled water for cooling, coils too need cooling.
The power supply is not functional now.
50V, 1250A air cooled, switched mode supply being procured for m-ICAL/e-ICAL.

Detector installation/maintenance trolley

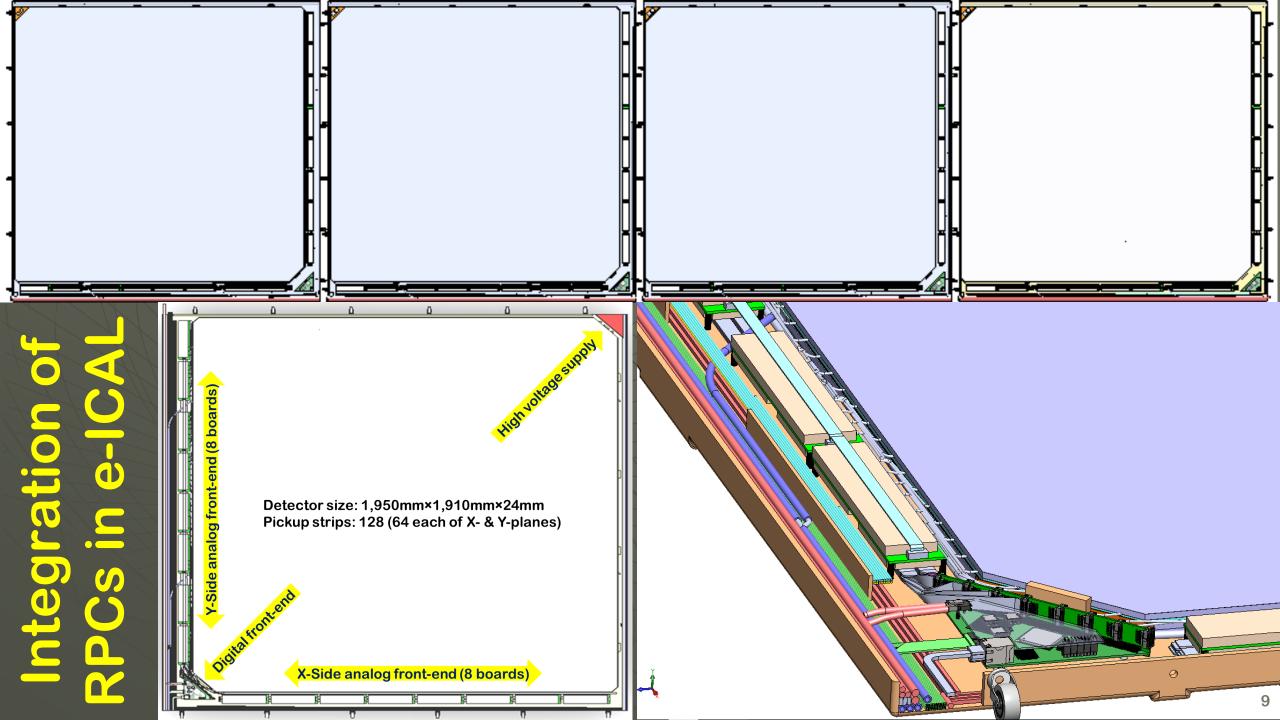


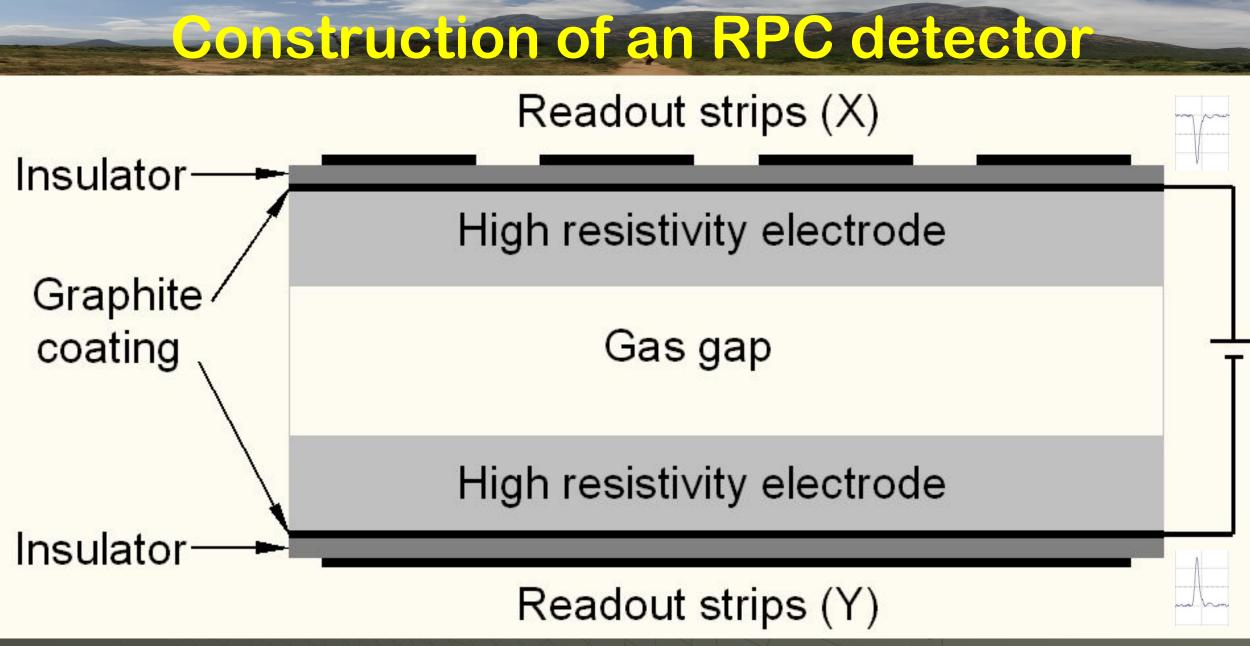


RPC insertion and extraction system is planned



Bengalur Automation Sunlight PCM.





***** Resistive materials like glass or bakelite for electrodes

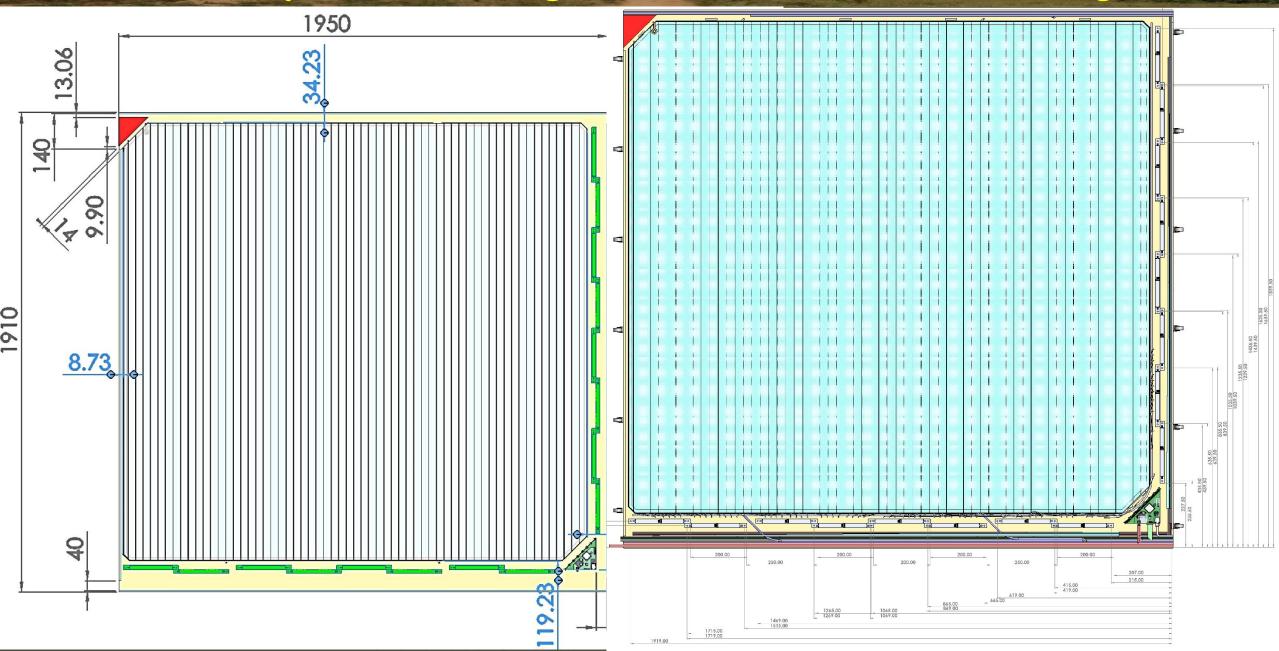
- Special paint mixture (developed locally) for semi-resistive coating
- Plastic honey-comb laminations used as readout panel
- ✤ Avalanche mode of operation using three component gas mixture: R134a:Isobutane:SF₆::95.5:4.2:0.3

A fully assembled 2m×2m RPC detector

EMI/EMC tests carried out at SAMEER, but some concerns still exist. To do. 11

3

Component layout on the RPC tray



Inks for glass electrode coating



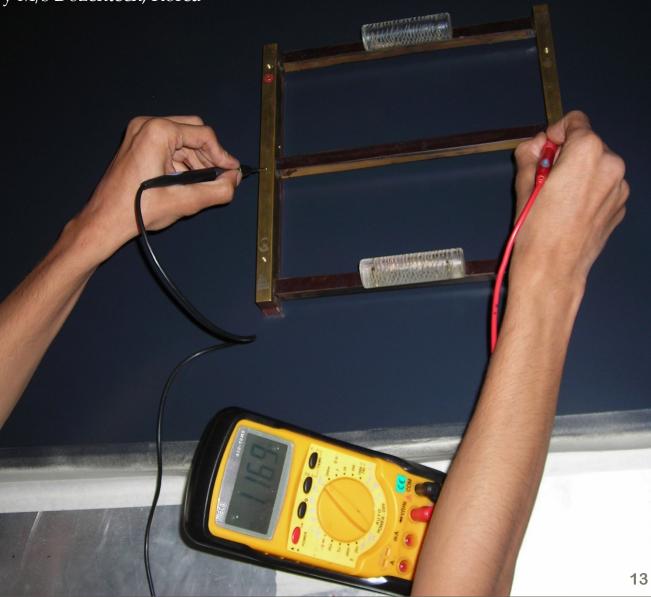
Screen printing ink Carbon Heat DC-1000M and DC-20 by M/s Dozentech, Korea

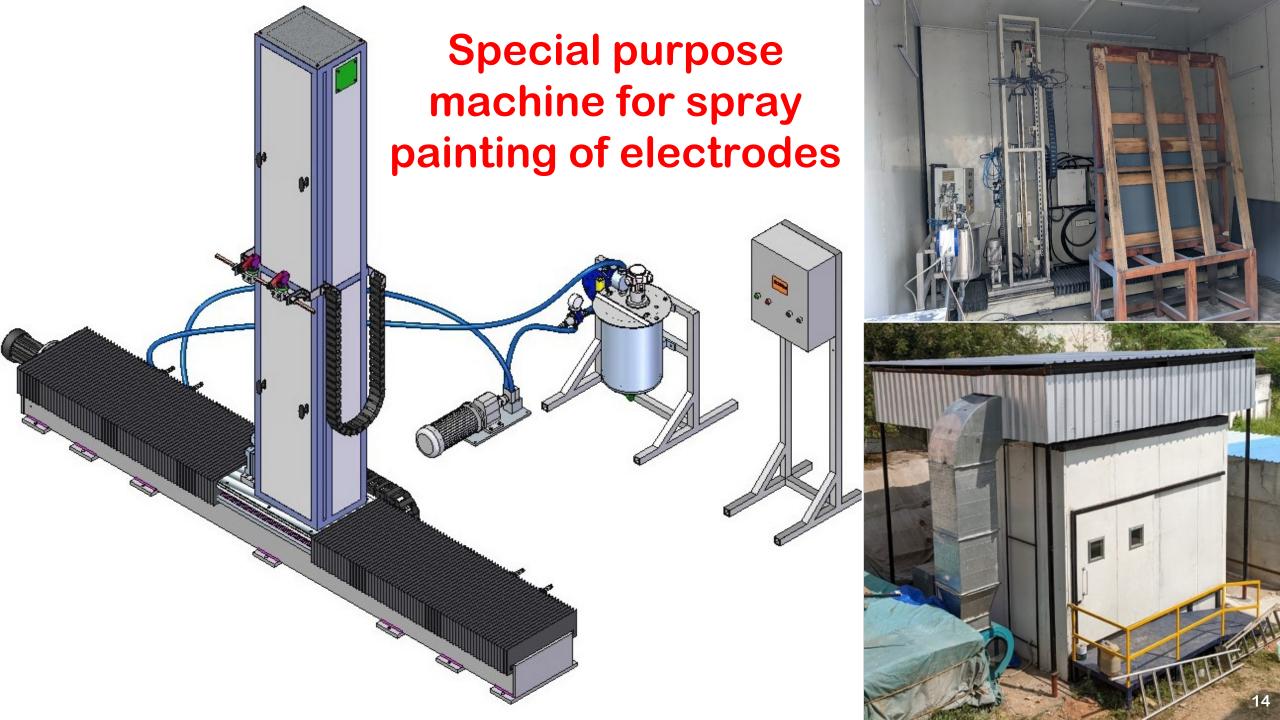
Regd office : Post Box No. 16322, Nerolac House, Ganpatrao Kadam Marg, Lower Parel, Mumbai – 400 013 Tel. : 022-2493 4001 / 2492 8008 FAX : 022-493 5742 E-Mail : gnpnet @ bom3.vsnl.net.in

PRODUCT	REF. NO.	REVISION	DATE	PAGE	
DATA	1026040	00	09.12.2020	1/1	
SHEET	1020040	00	09.12.2020	1/1	

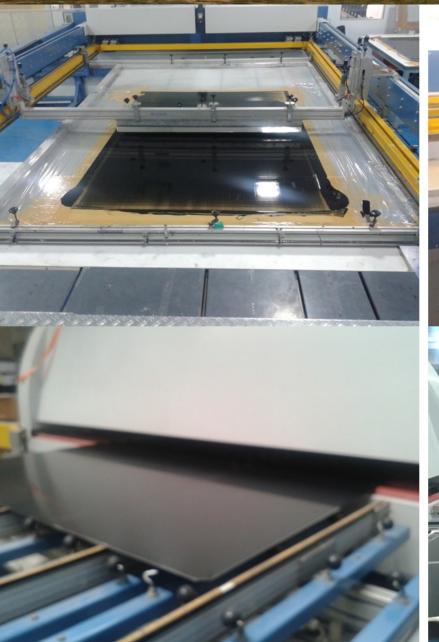
PRODUCT: CONDUCTIVE COATINGS BLACK FOR GLASS

01	Supply Weight / 10 I	$11.05 K_{\alpha+3}\%$
11000000	Supply Weight / 10 L	11.05 Kg±3%
02	Supply Viscosity	25 ± 05 Sec by F/C B-4 @ 30°C
03	Total Solids by wt (Comp A)	40 ± 3 % by Kg
04	Recommended Thinner	1000052
05	Thinner Intake	15 ± 5 % by wt
06	Application	By spraying at 18±2 sec viscosity by F/C.B-4 @ 30°C
07	Recommended DFT	25 μ
08	Comp B	HARDNER for Conductive Coatings Black for Glass
09	Mixing Ratio	Comp. A : Comp. B =100 : 05 by wt
10	Pot Life	5 hrs
11	Stoving Schedule	Air Dry
12	Color	Grey
13	Finish	Smooth & Glossy
14	Shelf Life	Six months from the date of manufacturing under normal storage conditions at 27-30°c when both the components are stored separately and away from contact of water and moisture. Thinner intake should not be more than the double of the original after six month of storage.





Screen printing and RPC gap fabrication





Pickup panels for RPC detector readout

8

5

00

X-panel (61 strips) Strip width: 28mm, gap: 2mm Aluminium: 40µm, Copper: 80µm Core: PVC 5mm thick, density: 0.7gm/cc

Y-panel (58 strips) Strip width: 28mm, gap: 2mm Aluminium: 40µm, Copper: 80µm Core: PVC 5mm thick, density: 0.7gm/cc

1746.00

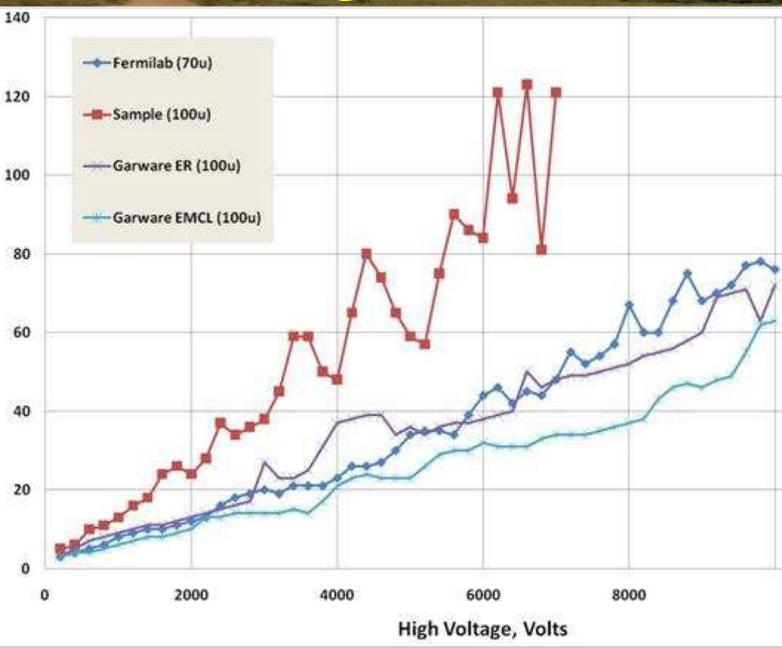
1851.00

Pickup panels produced in industry

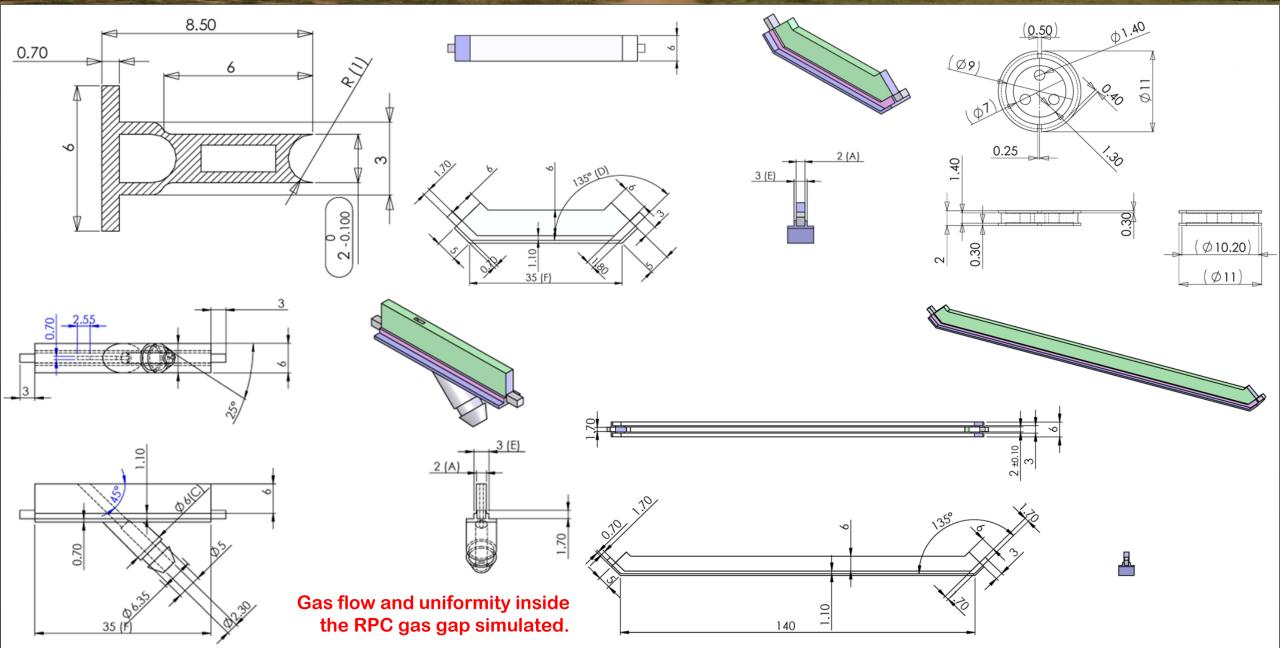
Mechanised mounting of terminations and soldering of cables planned.

Mylar sheet for insulating RPC bias

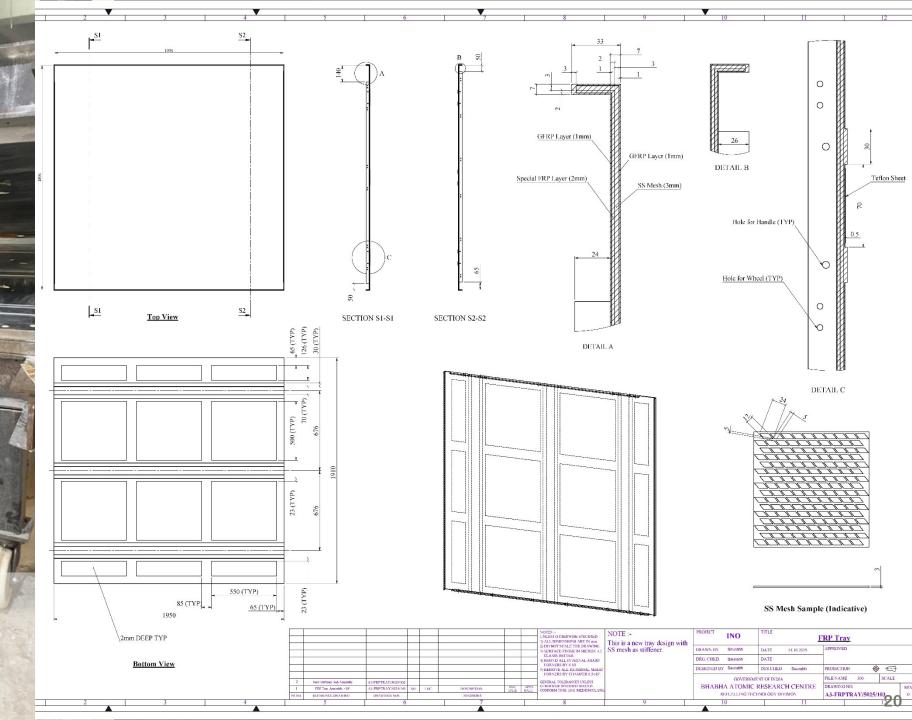
Property	Unit	Target	=
Thickness	μ m	100.0	-
Yield	m²/kg	7.1	-
Tensile strength	kg/cm ²		-
MD		2000	-
TD		2000	4
Elongation	%		Leakage current, nA
MD		135	ren
TD		120	cur
Shrinkage @150°C	%		age
MD		1.1	eak
TD		0.4	
Shrinkage @190°C	%		-
MD		2.0	-
TD		1.0	-
Haze	%	2.0	-
Coeff. of friction		0.45	-
Standard length	m	1500	-
Width tolerance	mm	± 2	-



Polycarbonate parts for gas gap fabrication



FRP tray drawing and RPC tray manufacturing unit

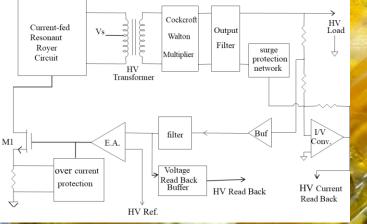


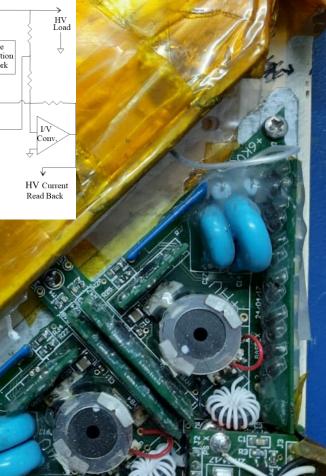
A fabricated FRP tray to host the RPC



High voltage power supply for RPC bias

1. No of HV channels	2 channels one +ve and one -ve HV
2. O/P voltage	Adjustable from 0 to ±6 kV.
3. O/P voltage setting and monitoring resolution	2V
4. O/P voltage setting vs. monitoring accuracy	±0.7% of F.S.
5. Max. O/P current	2μΑ
6. O/P current monitoring resolution	5nA
7. O/P current monitoring accuracy	± 0.5% of F.S.
8. Programmable overvoltage limit	0 to 6200V
9. Programmable over-current limit	0.5μA to 10μA
10. HV Ramp-up/down rate	0.5V - 200 V/ sec in 9 discrete steps
11. Output-ripple and noise voltage	within 200mV (p-p)
12. HV load regulation	Better than 0.05% F.S
13. HV output connection	Through 6" long flying HV leads
14. Remote voltage programming interface	Through SPI / RS-232 links
15. LV Input supply requirement	12V (±5%) @ 250mA (max)
16. Mechanical size	11×11 cm triangular, 26 mm (H)
17. Ambient operating temperature range	5°C to 50°C
18. Allowed ambient magnetic field	50 mT (max)





22

Low voltage power supply and distribution

High Voltage Supply

- * Voltage rail: +12V
- Voltage regulation: ± 5%
- Aaximum current: 200mA
- Maximum ripple: 20 mV (p-p)
- Solution Monitoring: Input Voltage and Current

Analog Front-end

- Voltage rails: ± 5V
- Maximum current: 1280 mA ± 10% per rail
- * Monitoring: Input Voltage and Current

Digital Front-end

- ✤ Voltage rail: +5V to +6V
- Maximum current: 1500mA
- Aaximum ripple: 50mV (p-p)
- Monitoring: Input Voltage and Current
- * Protection:
 - Overvoltage: Input voltage shouldn't cross +10V
 - Short Circuit: Current supplied shouldn't not exceed 1800mA

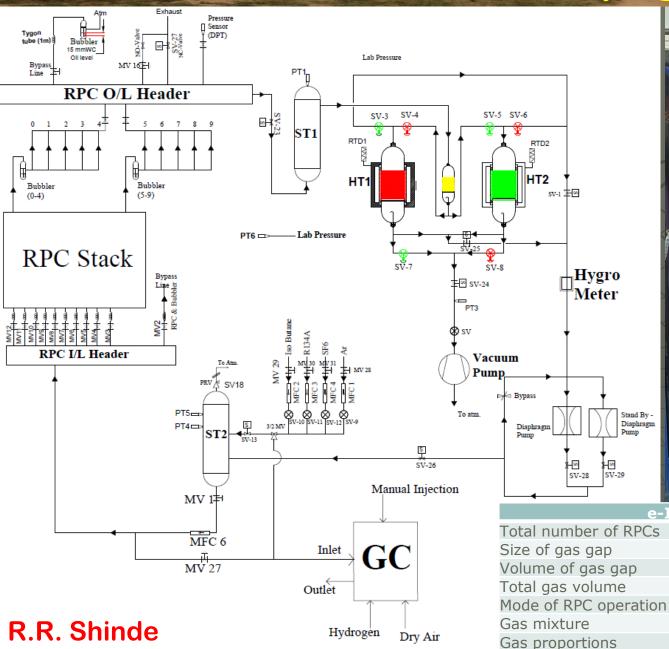




For representation purpose only

Closed loop gas system

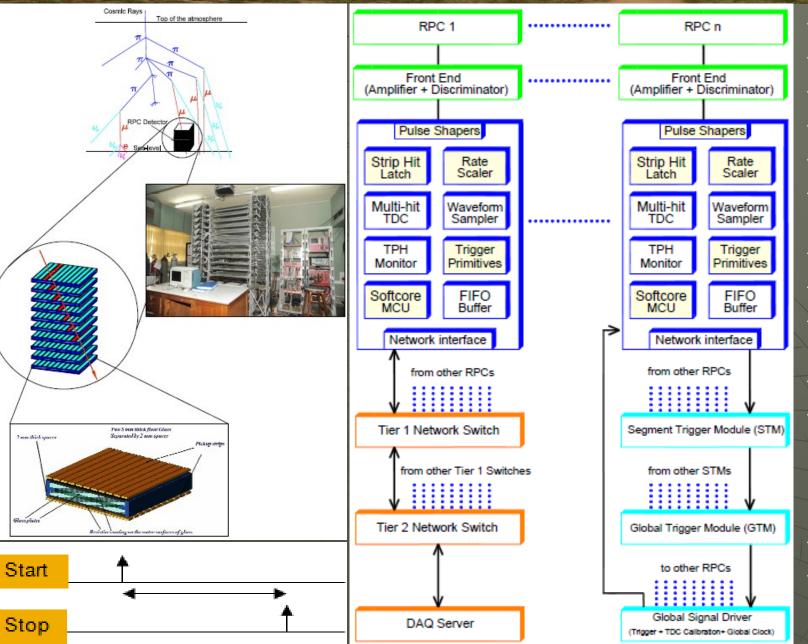
8-00 SV-29





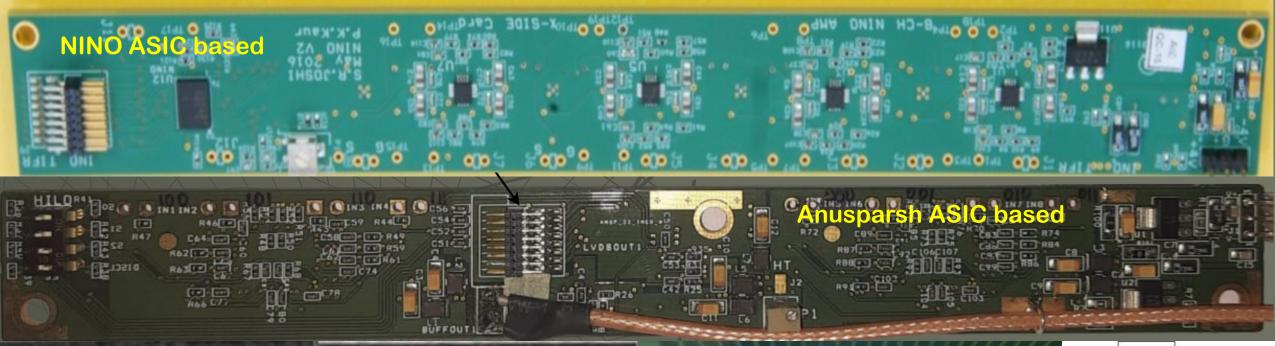
320 184.5×174×0.2 mm³ 6.5 Litres 2054 Litres Avalanche R134a:Iso Butane:SF₆ 95.2%:4.5%:0.3%

Electronics and DAQ systems



- Signal pickup and analog front-end
- Strip hit latch (1-bit ADC)
- Pulse shapers, timing units
- Background noise rate monitor
- Digital front-end and controller
- Data network interface and architecture
- Multilevel trigger system
- Backend data concentrators
- Event building, data storage systems
- On-line data quality monitors
- Slow control and monitoring
 - Gas system, magnet, power supplies
 - Ambient parameters (T, P and H)
 - Safety and interlocks
- Voice and video communications
- Remote access to detector subsystems and data

Analog Front End solutions

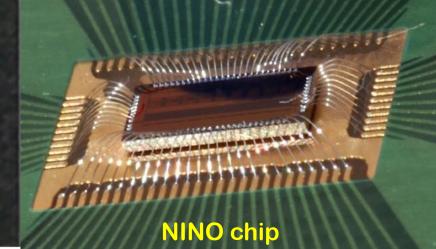


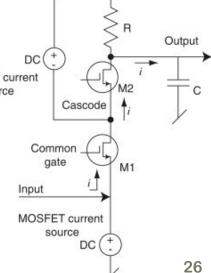
Anusparsh chip set

QFN-48 package

02

QFN-48 package

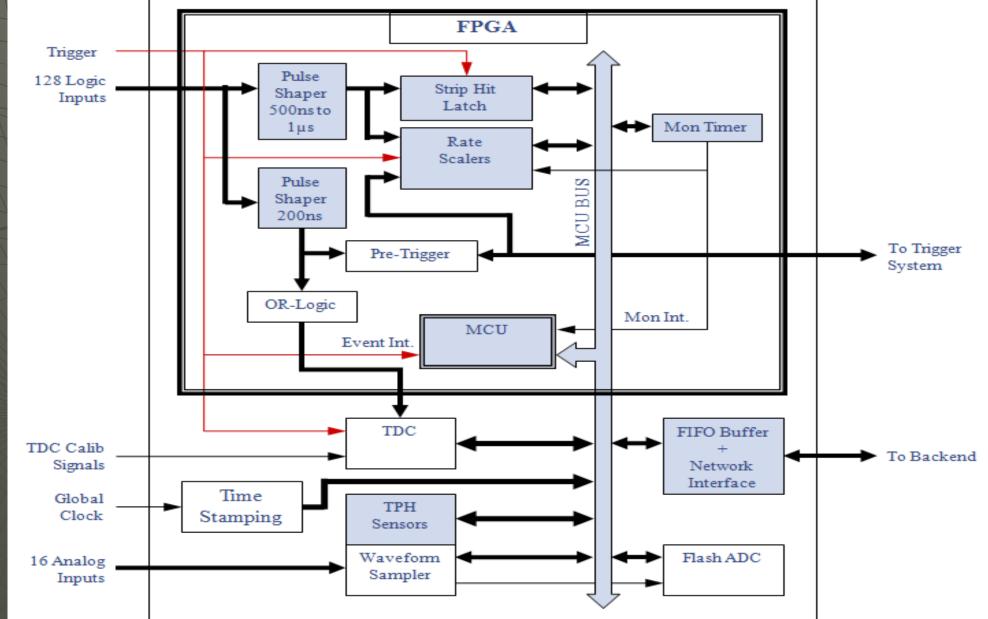




Digital Front End module

 Unshaped, digitized, LVDS
 RPC signals from
 128 strips (max)
 (64x + 64y)

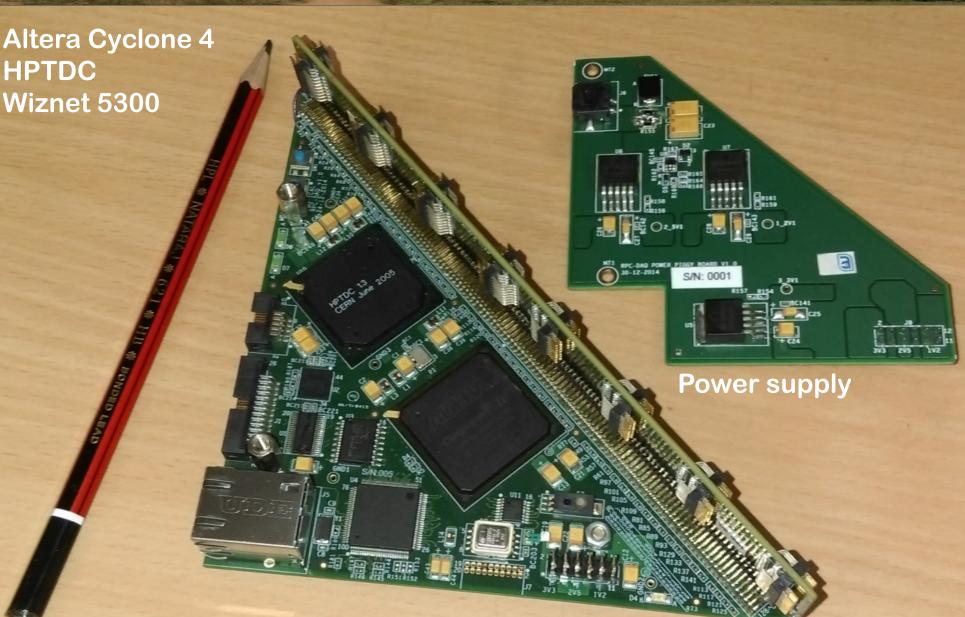
- 16 analog RPC signals, each signal is a summed or multiplexed output of 8 RPC amplified signals.
- Global trigger
- TDC calibration signals
- TCP/IP connection to backend for command and data transfer.



Digital Front End module

 Unshaped, digitized, LVDS
 RPC signals from
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- 16 analog RPC signals, each signal is a summed or multiplexed output of 8 RPC amplified signals.
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Development of TDC ASIC at IIT

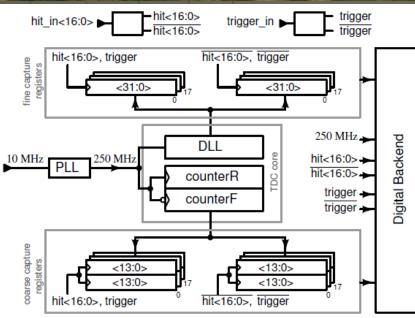
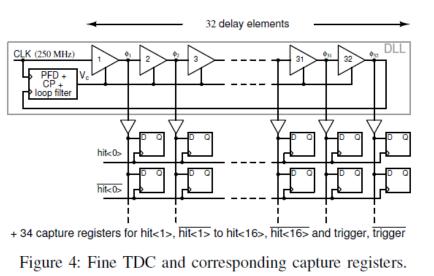
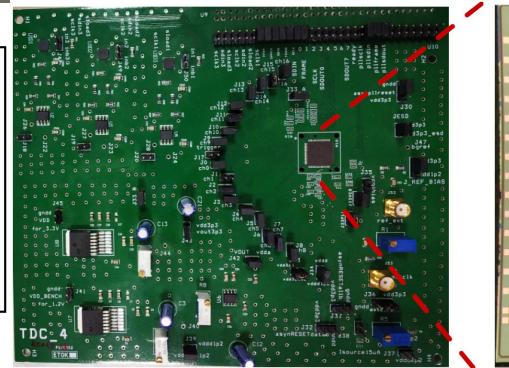


Figure 3: Top-level architecture.





Parameter	This work	[8] ^a	[5]	[20]	[3]	[27]	[28] ^b
Process (nm)	130	250	65	130	350	130	45
Channels	18	32	8	8	7	8	1
Multi-hit depth	4	dynamic	NA ^c	NA ^c	3	NA ^c	dynamic
LSB (ps)	125	98	102	5	8.88	74	25
Single-shot Precision (ps) ^d	65.34	90 ^e	95^{f}	3.45^{e}	9.8	75^{e}	-
Range (μ s)	65.5	51.38	0.418	0.0006	74	0.038	0.0008
Clock (MHz)	10	40	NA ^g	1562.5	20	NA ^g	1250
Power/channel(mW)	3.4	25	29	34 - 42	12.14	0.237	16
Area (mm ²)	3.72	-	0.3	1.2	8.88	0.163	0.36 29

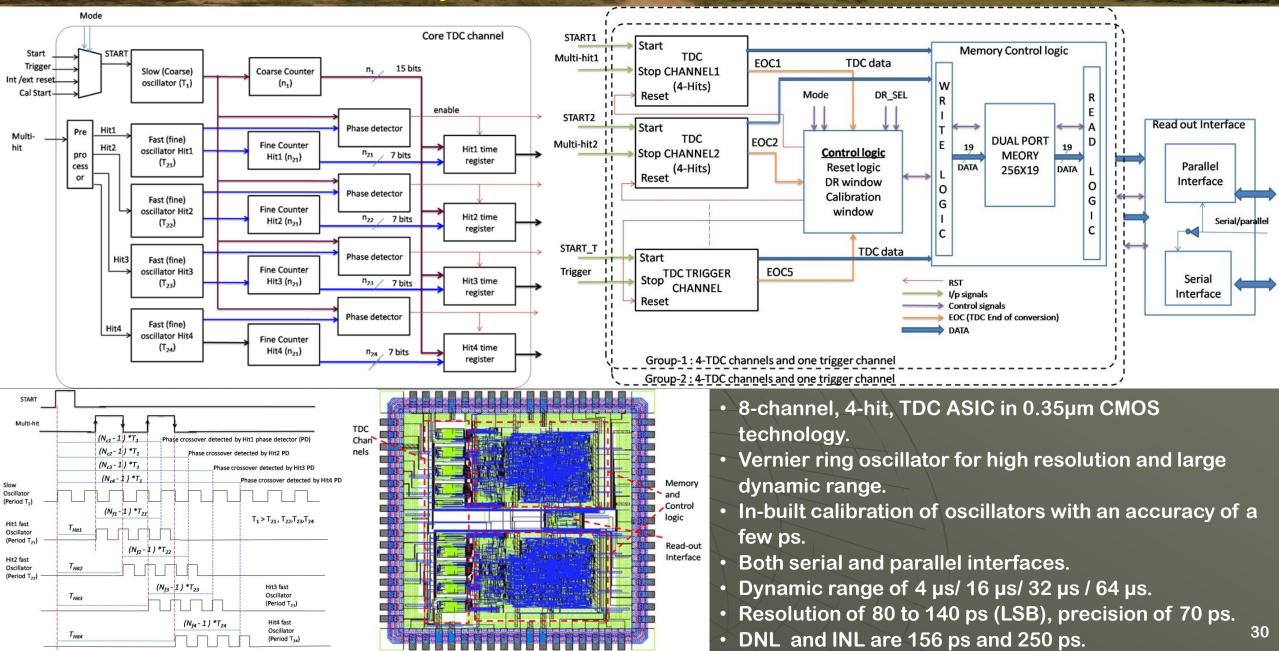
Capture Registers

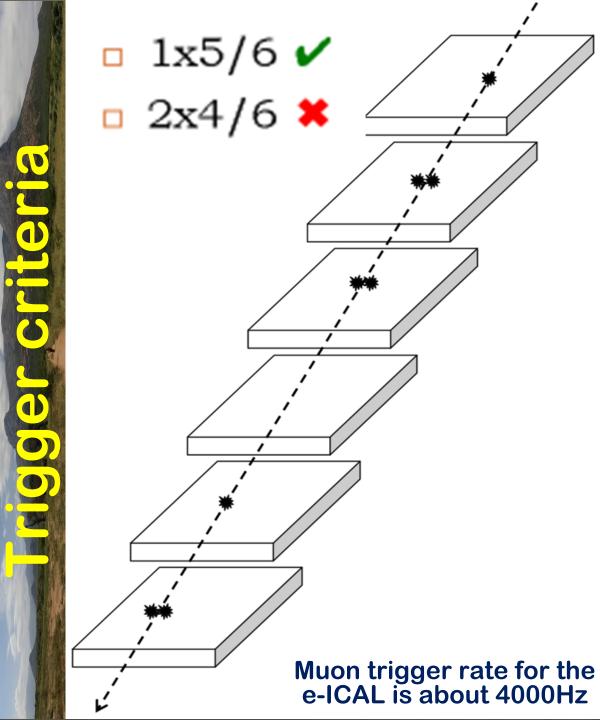
Backend

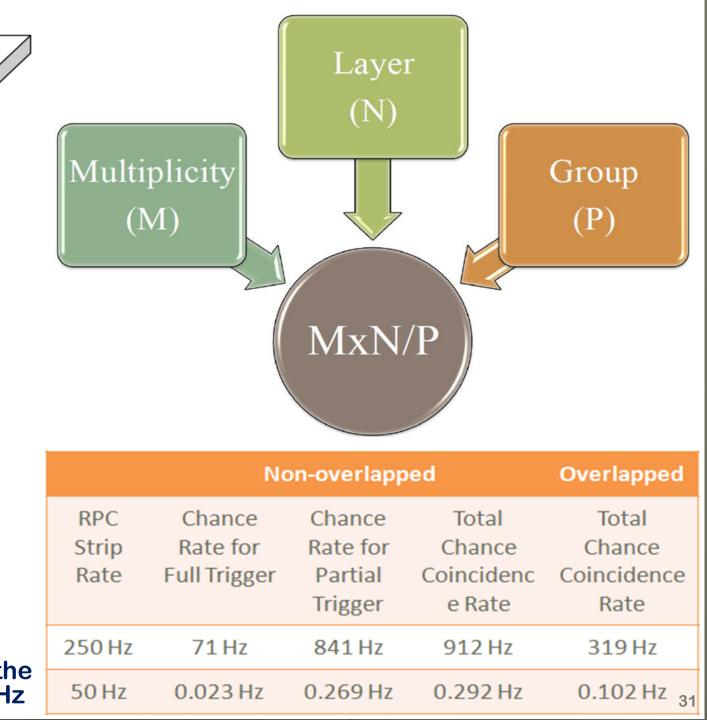
Core

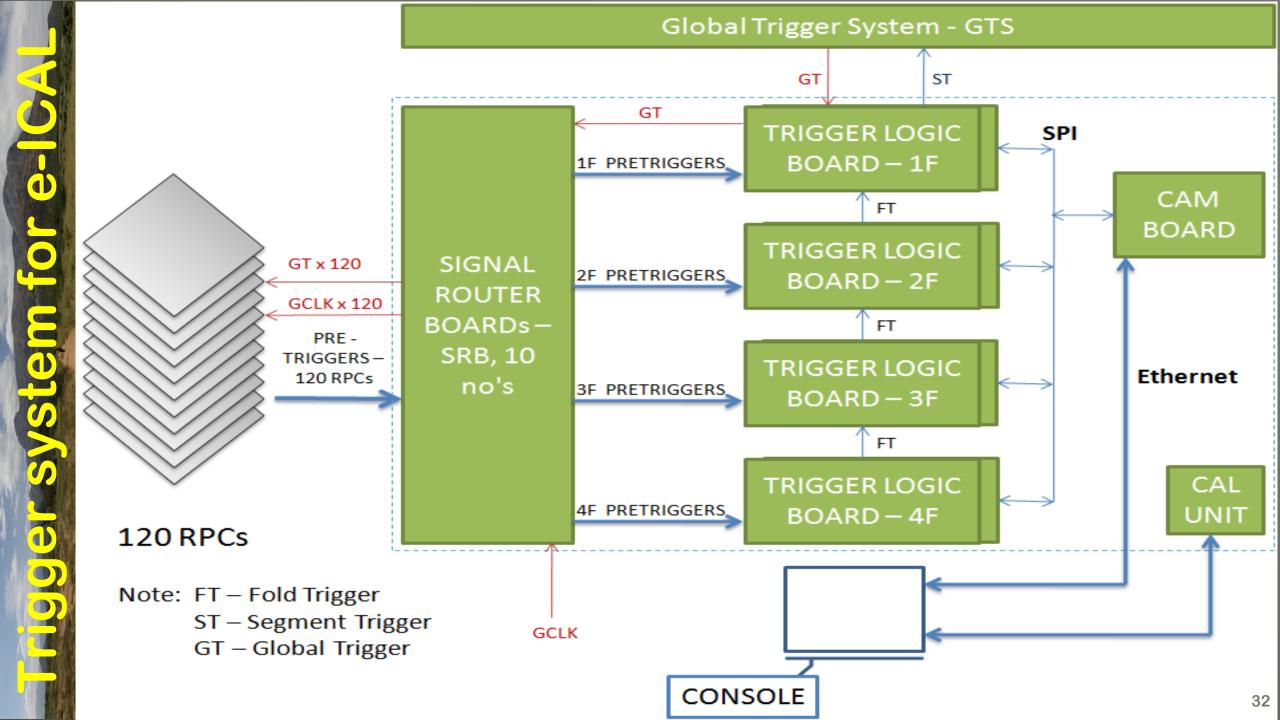
TDC

Development of TDCs BARC

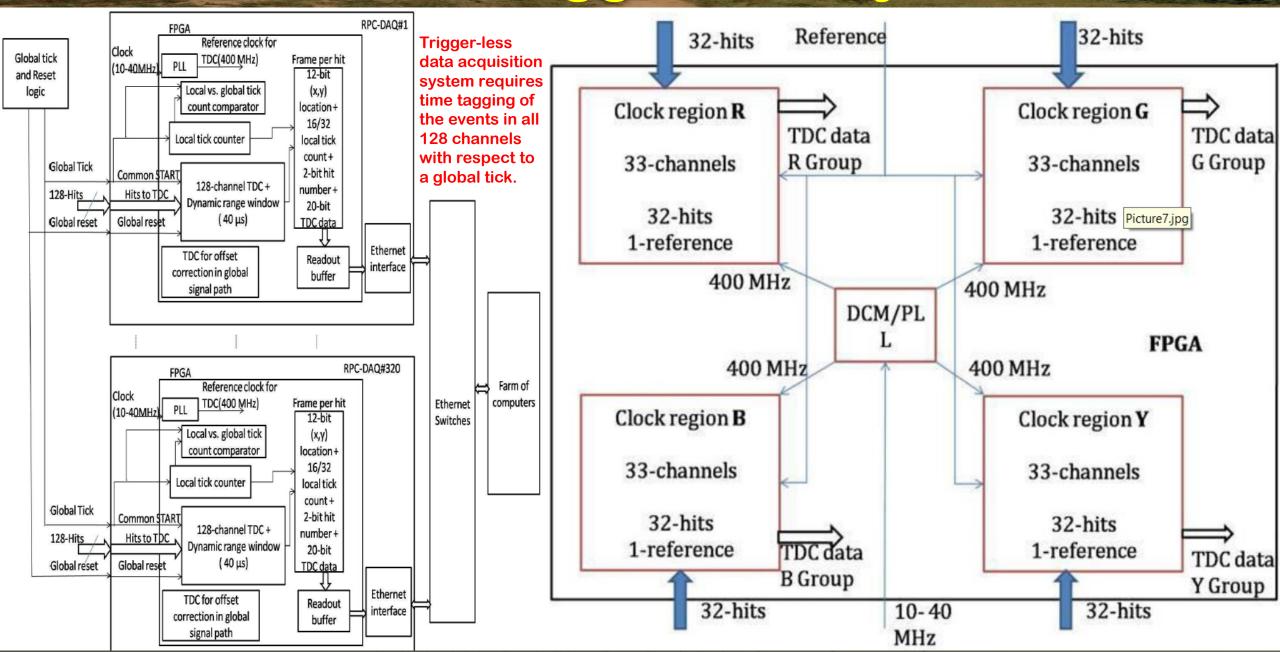


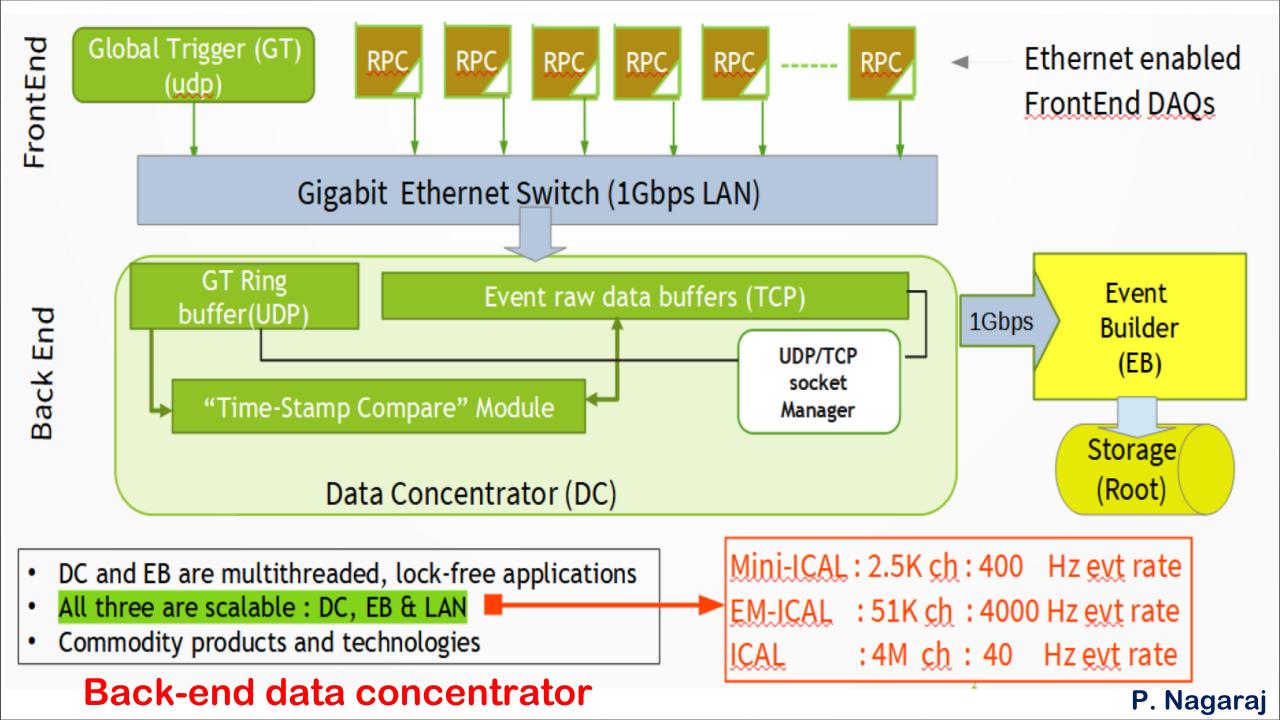






Towards trigger-less system





Conclusions and future plans

- Most of the magnet, detector, gas system and electronics related components and systems were developed.
- They are also being tested in the mini-ICAL detector for about four years. Good experience gained.
- RPC production by the industry is a bit of concern; operation too, especially at the scale envisaged for ICAL.
- Industrial production of components not yet started.
- All the approvals for the IICHEP site obtained, but project site's approval is stuck in legal and political tangles.
- ◆ Therefore, an air of uncertainty continues to prevail about the e-ICAL at the IICHEP, Madurai site too ②.